

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L8	0	7 and ((resin with substrate) and ((organic or "cyclo olefin" "cycloolefin") and (thermal with expansion with crystalliz\$)))	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/28 16:05
L7	299	((257/e33.06) or (257/e33.064) or (257/e31.126)).CCLS.	FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/03/28 16:05
L6	0	2 and 4	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/28 16:05
L5	0	4 and 2	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/28 16:05
L4	772	((257/e33.06) or (257/e33.064) or (257/e31.126)).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/03/28 16:05
L2	61	(resin with substrate) and ((organic or "cyclo olefin" "cycloolefin") and (thermal with expansion with crystalliz\$))	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/28 16:05
L3	0	1 and 2	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/28 16:00
L1	2313	((438/22) or (438/98)).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/03/28 15:48
S1	1	("6110347").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/03/28 15:47
S64	0	S63 and (thermal with expansion with stress)	FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 15:42
S63	48	S59 and (ito or (indium adj tin adj oxide)) with (crystallizing anneal\$4 rta rtp heat\$4)	FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 15:42
S61	19	S60 and (thermal with expansion with stress with layer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 15:42
S62	0	S60 and (ito or (indium adj tin adj oxide)) with (crystallizing anneal\$4 rta rtp heat\$4)	FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 15:41

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S60	1012	S50 and (ito or (indium adj tin adj oxide)) with (crystallizing anneal\$4 rta rtp heat\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 15:41
S56	100	S53 and (thermal with expansion with stress with layer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 15:22
S59	93448	(substrate or wafer) with (resin)	FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/23 15:21
S58	0	S55 and (thermal with expansion with stress)	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 15:21
S57	0	S55 and (thermal with expansion with stress with layer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 15:21
S55	89	S50 and (ito or (indium adj tin adj oxide)) with (crystallizing anneal\$4 rta rtp)	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 15:21
S50	93236	(substrate or wafer) with (resin)	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 15:21
S53	100	S51 and (thermal with expansion with stress with layer)	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 15:20
S51	15352	S50 and (ito or (indium adj tin adj oxide))	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 15:19
S54	1	("6677062").PN.	USPAT; USOCR	OR	OFF	2007/03/23 14:52
S52	378	S51 and (thermal with expansion with stress)	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/23 14:48